



## **JOB OPPORTUNITY**

**POSTING DATE:** June 14, 2006  
**DEPARTMENT:** Repair (Material Prep.)  
**REPORTS TO:** Repair Supervisor  
**JOB TITLE:** Electronic Tech. I – Assembly .  
**HOURS:** 1<sup>st</sup> Shift, Monday-Friday

### **DUTIES & RESPONSIBILITIES:**

- Perform light electronic and/or electromechanical assembly work of moderate complexity.
- Follow simple assembly and material preparation procedures.
- Work with parts or components that require special care in handling.
- Follow procedures and diagrams in performing engineering change orders as required.
- Solder through hole and surface mount device components on printed circuit boards.
- De-solder electronic components from printed circuit boards.
- Solder and de-solder BGA components on printed circuit boards; reball BGA chips as required.
- Identify opportunities for process improvements and suggest changes.

### **QUALIFICATIONS:**

- High school diploma or GED required. Associates degree in electronics preferred. Previous soldering experience required.
- Position requires lifting up to 50 lbs. on a non-repetitive basis. Manual dexterity needed for manipulation of small electronic parts, soldering and assembly work.